TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (L^2 - π -MOSV)

2SJ377

Relay Drive, DC-DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain–source ON resistance $: R_{DS (ON)} = 0.16 \Omega \text{ (typ.)}$ • High forward transfer admittance $: |Y_{fs}| = 4.0 \text{ S (typ.)}$

• Low leakage current $: I_{DSS} = -100 \,\mu\text{A} \,(\text{max}) \,(V_{DS} = -60 \,\text{V})$

• Enhancement-mode : $V_{th} = -0.8 \sim -2.0 \text{ V (V}_{DS} = -10 \text{ V, I}_{D} = -1 \text{ mA)}$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-60	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	-60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	-5	Α	
	Pulse(Note 1)	I _{DP}	-20	Α	
Drain power dissipation	n (Tc = 25°C)	P _D	20	W	
Single pulse avalanche energy (Note 2)		E _{AS}	273	mJ	
Avalanche current		I _{AR}	-5	Α	
Repetitive avalenche energy (Note 3)		E _{AR}	2	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

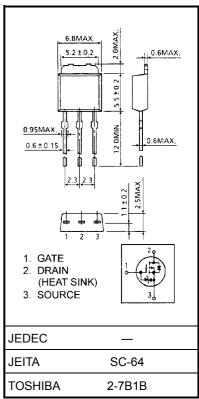
Note 2: V_{DD} = -25 V, T_{Ch} = 25°C (initial), L = 14.84 mH, R_G = 25 Ω , I_{AR} = -5 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

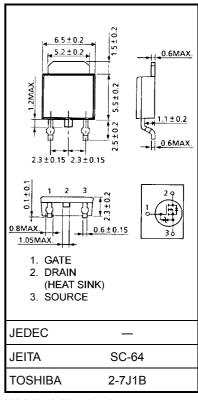
This transistor is an electrostatic sensitive device.

Please handle with caution.

Unit: mm



Weight: 0.36 g (typ.)



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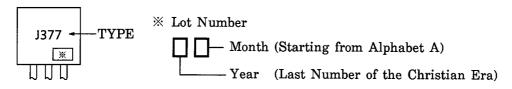
Electrical Characteristics (Ta = 25°C)

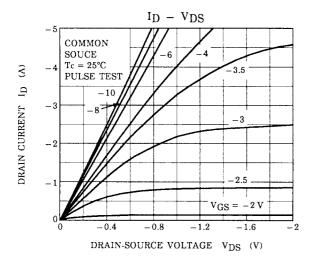
Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ	
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	_	_	-100	μΑ	
Drain-source br	eakdown voltage	V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-60	_	_	V	
Gate threshold v	oltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8	_	-2.0	V	
Drain-source ON resistance		R _{DS (ON)}	$V_{GS} = -4 \text{ V}, I_D = -2.5 \text{ A}$	_	0.24	0.28	Ω	
			V _{GS} = -10 V, I _D = -2.5 A	_	0.16	0.19		
Forward transfer	r admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -2.5 \text{ A}$	2.0	4.0	_	S	
Input capacitano	e	C _{iss}		_	630	_		
Reverse transfe	r capacitance	C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	95	_	pF	
Output capacitance		Coss			290	_	1	
Switching time	Rise time	t _r	$\begin{array}{c c} V_{GS} \stackrel{0V}{\longrightarrow} & I_{D} = -2.5 A \\ \stackrel{\sim}{\longrightarrow} & \stackrel{\sim}{\longrightarrow} & \stackrel{\sim}{\longrightarrow} & V_{OUT} \\ & \stackrel{\sim}{\longrightarrow} & \stackrel{\sim}{\longrightarrow} & 12 \Omega \\ & \stackrel{\sim}{\longrightarrow} & \stackrel{\sim}{\longrightarrow} & -30 V \end{array}$	_	25	_		
	Turn-on time	t _{on}		1	45	_	ns	
	Fall time	t _f		ı	55	_	. 115	
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\mathbf{W}} = 10 \mu \text{s}$	_	200	_		
Total gate charg plus gate-drain)		Qg		_	22	_		
Gate-source charge		Q _{gs}	$V_{DD} \approx -48 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$	_	16		nC	
Gate-drain ("miller") charge		Q _{gd}		_	6			

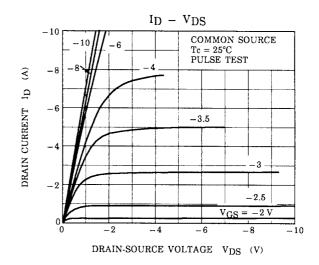
Source-Drain Ratings and Characteristics (Ta = 25°C)

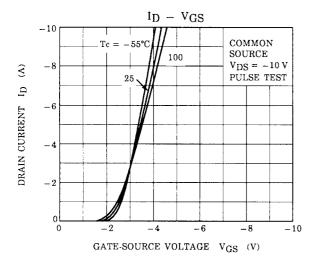
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	-5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	-20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = -5 A, V _{GS} = 0 V	_	_	1.7	V
Reverse recovery time	t _{rr}	I _{DR} = -5 A, V _{GS} = 0 V		80	_	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 50 A / μS	_	0.1	_	μC

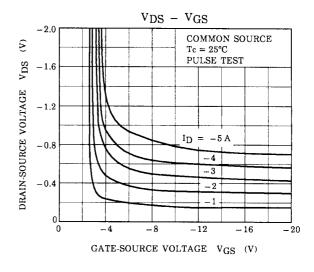
Marking

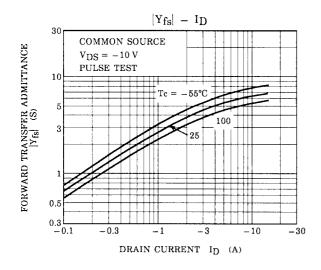


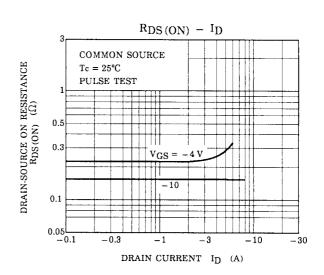




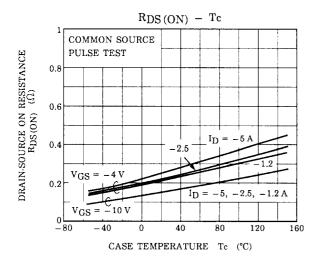


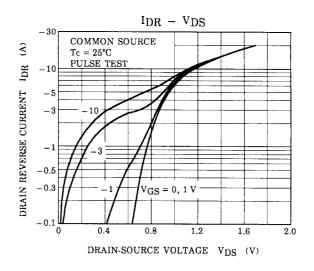


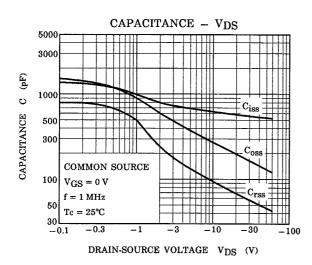


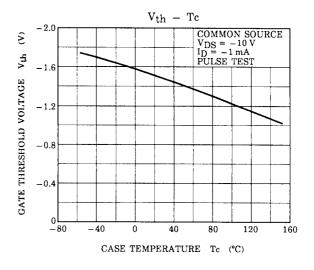


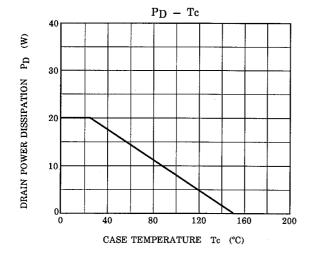
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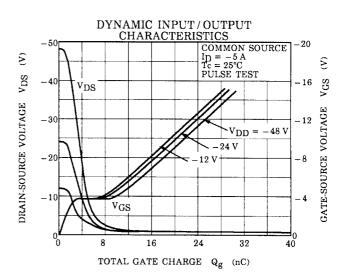




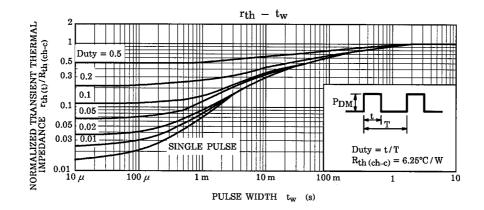


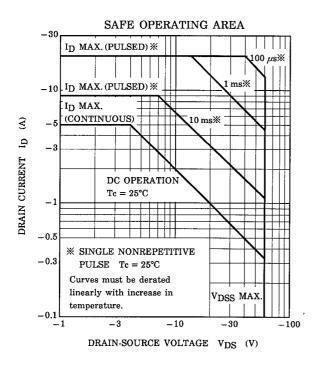


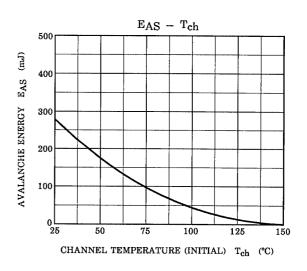


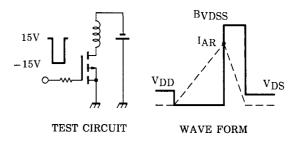


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$$\begin{array}{ll} R_G\!=\!25\Omega \\ V_{DD}\!=\!-25V,\; L\!=\!14.84mH \end{array} \quad E_{AS}\!=\!\frac{1}{2}\cdot L\cdot I^2\cdot (\frac{BV_{DSS}}{BV_{DSS}\!-V_{DD}}) \end{array}$$

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